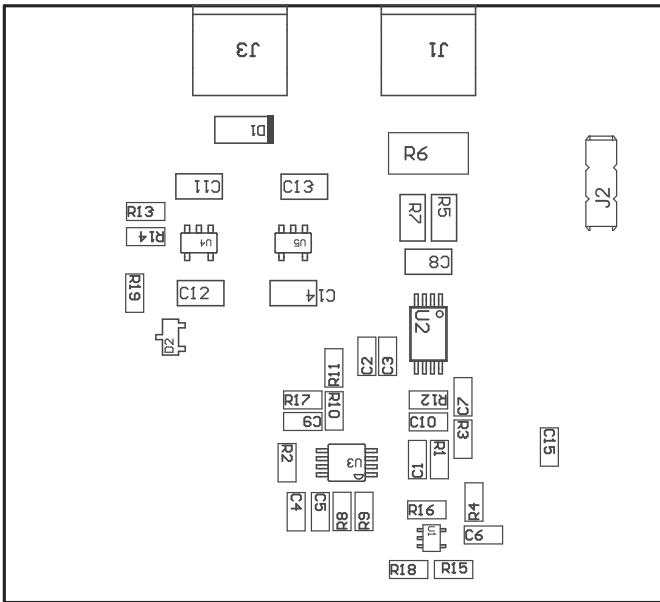
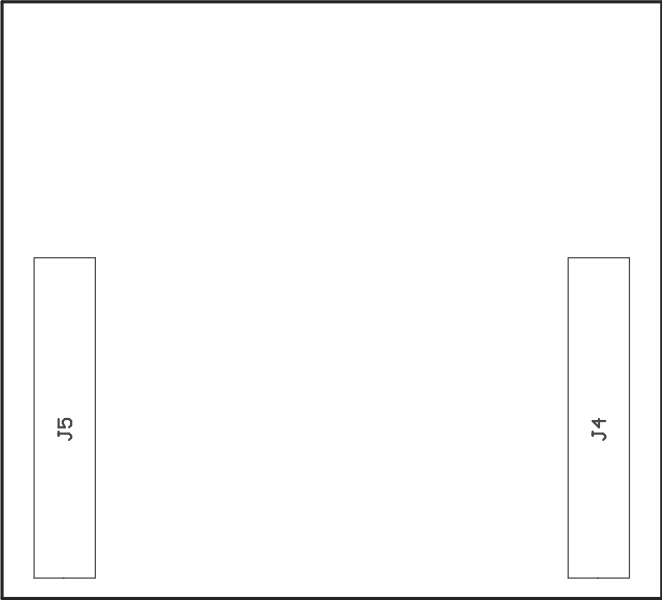


- ZZ1 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- ZZ2 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

| | | | |
|----------------------------------|----------------------|-------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE | BOARD #: TIDA-01421 | REV: E1 | SUN REV: Not In VersionControl |
| | TID #: TIDA-01421 | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 4/7/2017 | 10:56:07 AM | TEXAS INSTRUMENTS |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

| | | | |
|-------------------------------------|----------------------|-------------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE | BOARD #: TIDA-01421 | REV: E1 | SUN REV: Not In VersionControl |
| | TID #: TIDA-01421 | | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 4/7/2017 | 10:56:08 AM | TEXAS INSTRUMENTS |

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